


SANYO Semiconductors

DATA SHEET

LV4900H — Bi-CMOS LSI Class-D Audio Power Amplifier BTL 10W×2ch

Overview

The LV4900H is a 10W per channel stereo digital power amplifier that takes analog inputs. The LV4900H uses unique SANYO-developed feedback technology to achieve excellent audio quality despite being a class D amplifier and can be used to implement high quality flat display panel (FDP) based systems.

Features

- Supports circuit designs that do not require output LC filters
- BTL output, class D amplifier system
- Unique SANYO-developed feedback technology achieves superb audio quality
- High-efficiency class D amplifier
- Soft muting function reduces impulse noise at power on/off
- Full complement of built-in protection circuits : overcurrent protection, thermal protection, and low power supply voltage protection circuits
- Built-in bootstrap diodes
- Internal oscillator frequencies : channel 1 = 325kHz, channel 2 = 300kHz

Functions

- 10W output (At $V_D = 12V$, $R_L = 8\Omega$, THD + N = 10%)
- 15W output (At $V_D = 12V$, $R_L = 4\Omega$, THD + N = 10%)
- Efficiency : 88% ($V_D = 12V$, $R_L = 8\Omega$, $f_{in} = 1kHz$, $P_O = 10W$)
- Low THD + N : 0.15% ($V_D = 12V$, $R_L = 8\Omega$, $f_{in} = 1kHz$, $P_O = 1W$, Filter : AES17)
- Noise : 100 μ Vrms (Filter : A-weight)

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LV4900H

Specifications

Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	VD	Externally applied voltage	15	V
Maximum output current	IO peak		3.75	A/ch
Allowable power dissipation	Pd max	Independent package	886	mW
Operating temperature	Topr		-25 to +75	°C
Storage temperature	Tstg		-50 to +150	°C

Operating Conditions at Ta = 25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Recommended supply voltage range	VD	Externally applied voltage	10	12	14	V
Recommended load resistance	RL	Speaker load	4	8		Ω

Electrical Characteristics at Ta = 25°C, VD = 12V, RL = 8Ω, L = 22μH, C = 0.33μF

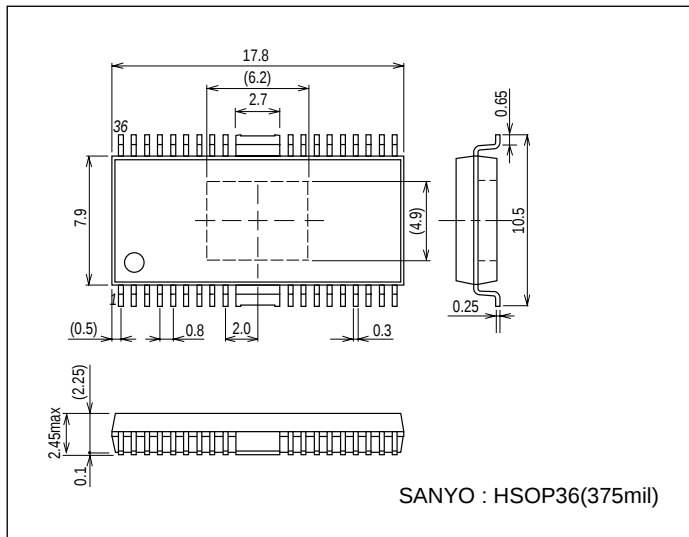
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Standby current	Ist	STBY = L, MUTE = L		13	25	μA
Muting current	Imute	STBY = H, MUTE = L		13.5	20	mA
Quiescent current	ICCO	STBY = H, MUTE = H		60	70	mA
Voltage gain	VG	fin = 1kHz, VO = 0dBm	27	29	31	dB
Output offset voltage	Voffset	Rg = 0	-150		150	mV
Total harmonic distortion	THD@1W	PO = 1W, fin = 1kHz, AES17		0.15	0.5	%
Maximum output	PO1@10%	THD+N = 10%, AES17	8	10		W
Channel separation	CH sep.	Rg = 0, VO = 0dBm, DIN AUDIO	55	70		dB
Ripple rejection ratio	SVRR	fr = 100Hz, Vr = 0dBm, Rg = 0, A-weight	50	65		dB
Noise	VNO	Rg = 0, A-weight		100	300	μVrms
High-level output voltage	VIH	STBY pin and MUTE pin	3			V
Low-level output voltage	VIL	STBY pin and MUTE pin			1	V
Power supply voltage drop protection circuit upper limit value	UV_UPPER	VD pin voltage monitor		8.0		V
Power supply voltage drop protection circuit lower limit value	UV_LOWER	VD pin voltage monitor		7.0		V

Note : The values of these characteristics were measured in the SANYO test environment. The actual values in an end system will vary depending on the printed circuit board pattern, the external components actually used, and other factors.

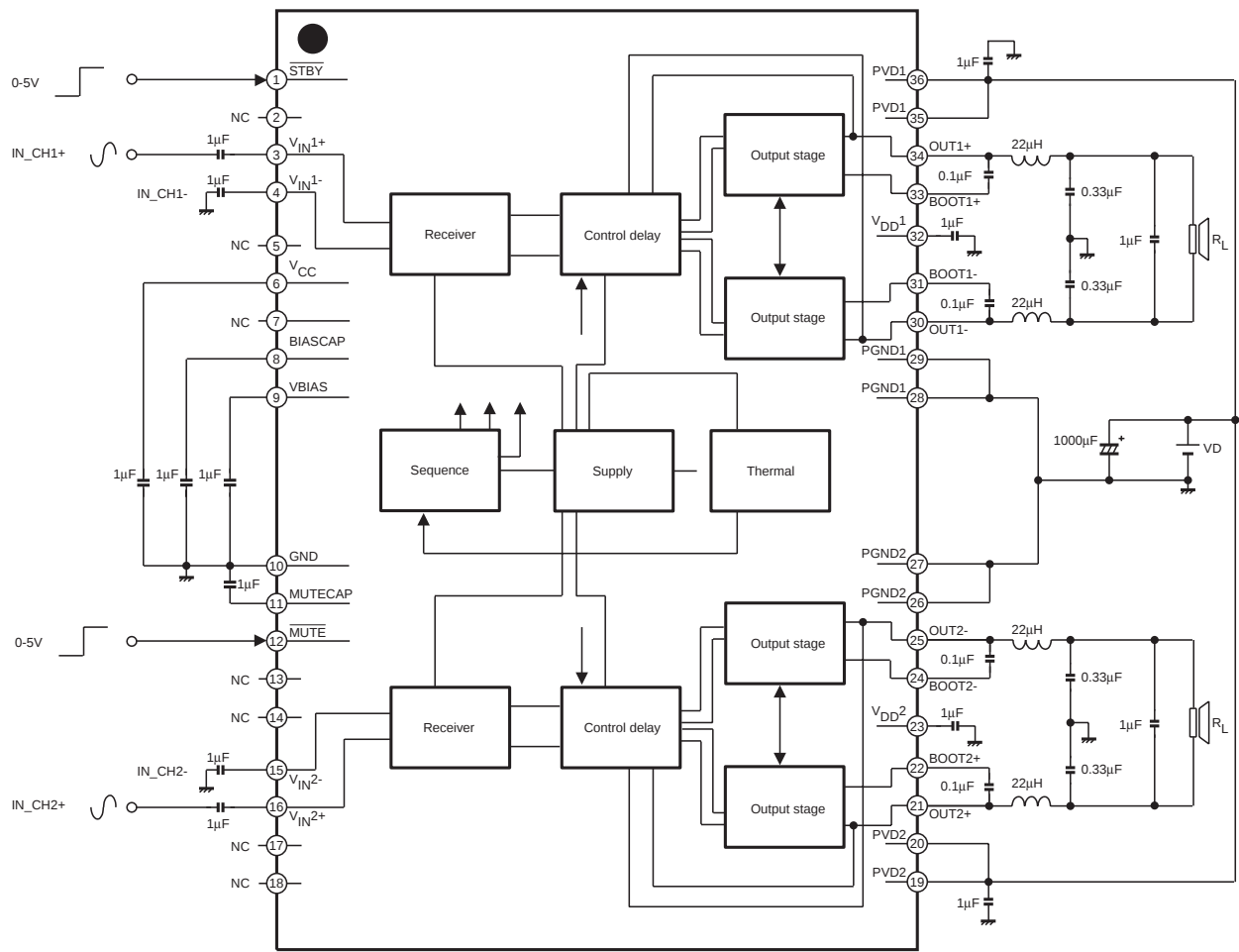
Package Dimensions

unit : mm (typ)

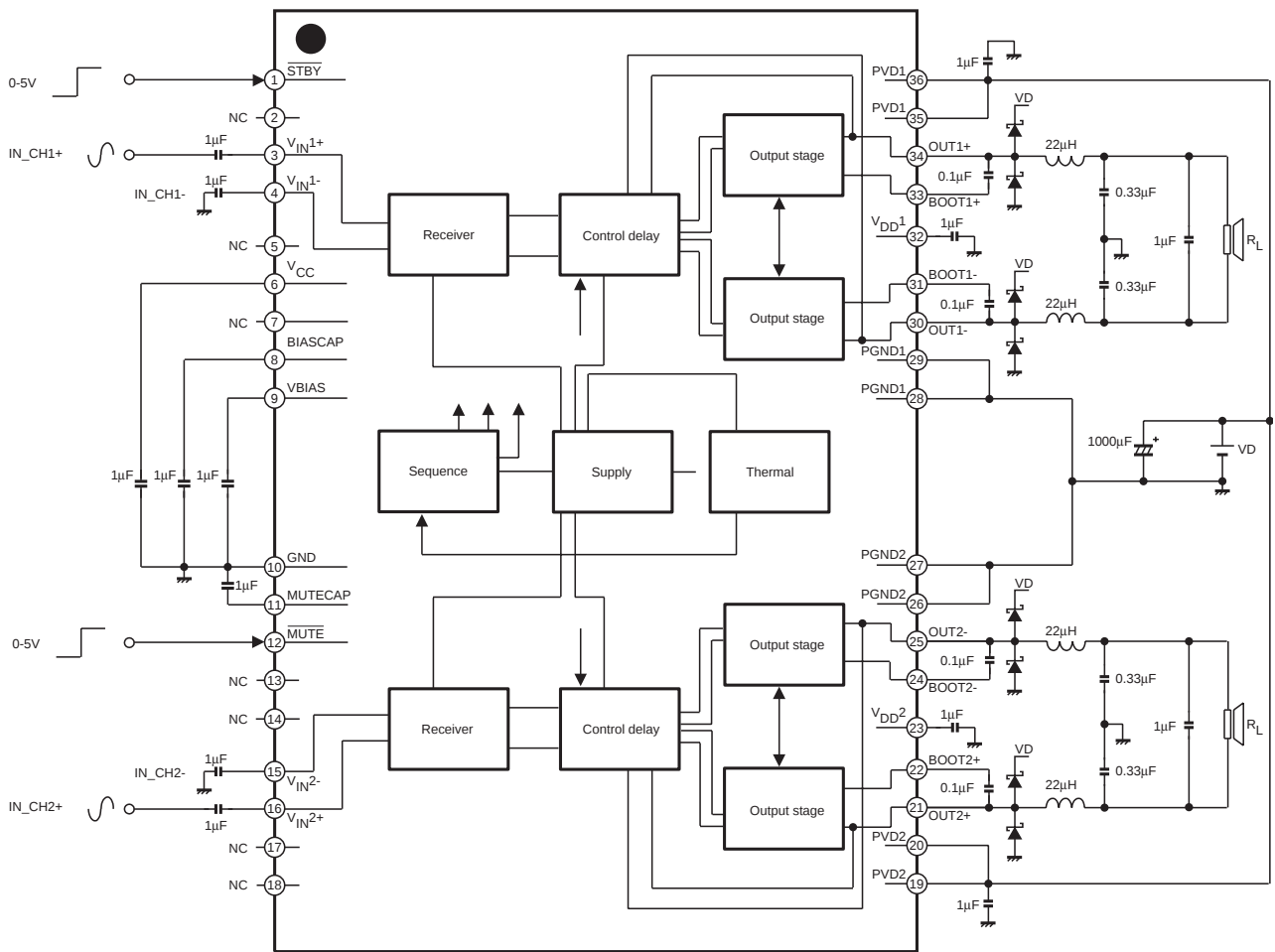
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Block Diagram and Application Circuit Example 1 ($R_L = 8\Omega$)



Application Circuit Example 2 ($R_L = 4\Omega$)



Pin Equivalent Circuit

Pin No.	Pin	I/O	Description	Equivalent Circuit
1	STBY	I	Standby mode control	
2	NC		No connection	
3	V _{IN1+}	I	Channel 1 noninverting input	
4	V _{IN1-}	I	Channel 1 inverting input	
5	NC		No connection	
6	V _{CC}	O	Internal power supply decoupling capacitor connection	
7	NC		No connection	
8	BIASCAP	O	Internal power supply decoupling capacitor connection	

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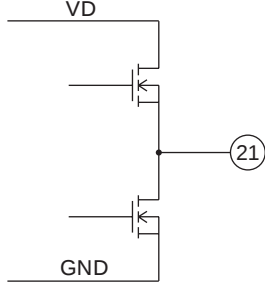
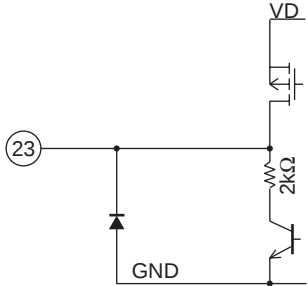
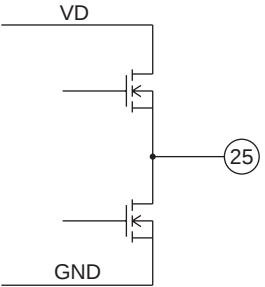
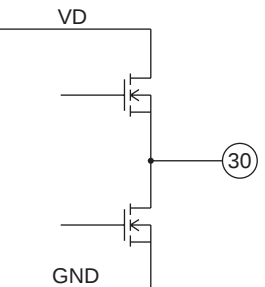
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Pin No.	Pin	I/O	Description	Equivalent Circuit
9	VBIAS	O	Internal power supply decoupling capacitor connection	
10	GND		Analog system ground	
11	MUTECAP	O	Muting system capacitor connection	
12	MUTE	I	Muting control	
13	NC		No connection	
14	NC		No connection	
15	V _{IN2} -	I	Channel 2 inverting input	
16	V _{IN2} +	I	Channel 2 noninverting input	
17	NC		No connection	
18	NC		No connection	
19	PVD2		Channel 2 power system power supply	
20	PVD2		Channel 2 power system power supply	

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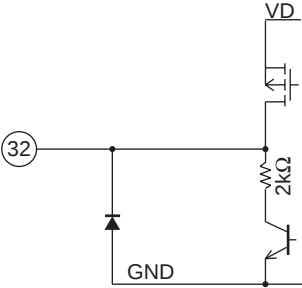
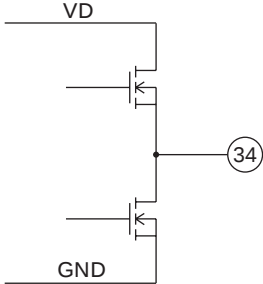
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Pin No.	Pin	I/O	Description	Equivalent Circuit
21	OUT2+	O	Channel 2 high side output	
22	BOOT2+	I/O	Bootstrap I/O pin, channel 2 power supply high side	
23	V _{DD2}	O	Internal power supply decoupling capacitor connection	
24	BOOT2-	I/O	Bootstrap I/O pin, channel 2 power supply low side	
25	OUT2-	O	Channel 2 low side output	
26	PGND2		Channel 2 power system ground	
27	PGND2		Channel 2 power system ground	
28	PGND1		Channel 1 power system ground	
29	PGND1		Channel 1 power system ground	
30	OUT1-	O	Channel 1 low side output	
31	BOOT1-	I/O	Bootstrap I/O pin, channel 1 power supply low side	

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Pin No.	Pin	I/O	Description	Equivalent Circuit
32	V _{DD1}	O	Internal power supply decoupling capacitor connection	
33	BOOT1+	I/O	Bootstrap I/O pin, channel 1 power supply high side	
34	OUT1+	O	Channel 1 high side output	
35	PVD1		Channel 1 power system power supply	
36	PVD1		Channel 1 power system power supply	

Note : Smoothing capacitors must be connected to each power supply pin.

Functional Descriptions

System Standby

The bias levels are turned on and off under control of the high/low state of the STBY pin. When the STBY pin is low, the bias levels will be turned off, and when that pin is high, the bias levels will be applied.

Mute Function

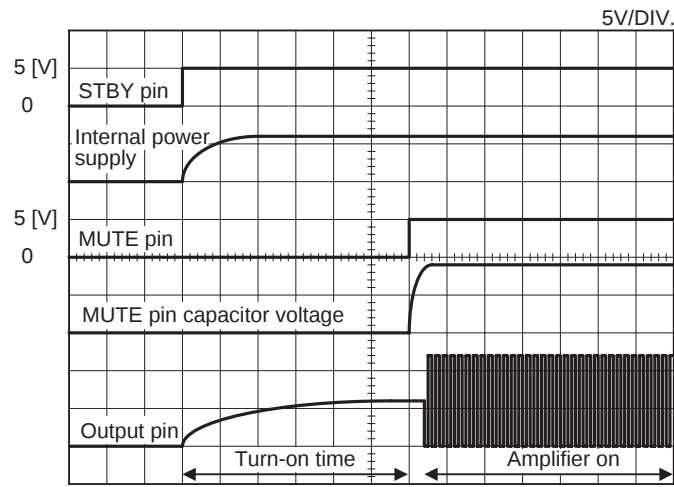
The mute function is provided mainly to mute the output so that impulse noise will not appear in the output when the power supply is being turned on.

(1) Output Muting

The output PWM signal can be turned on or off by setting the MUTE pin high or low. When the MUTE pin is low, the internal oscillator is stopped. This oscillator operates at all times that the MUTE pin is high.

(2) Power On Sequence

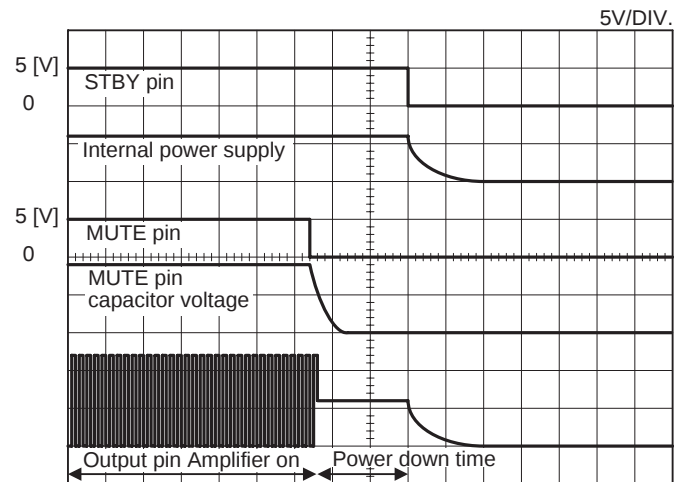
Applications should provide a power-on muting period of at least 500ms to minimize impulse noise.



Turn-on time : the time between the point the STBY pin is set high and the point the MUTE pin is set high.

(3) Power Down Sequence

Applications should provide a power down muting period of at least 100ms to minimize impulse noise.

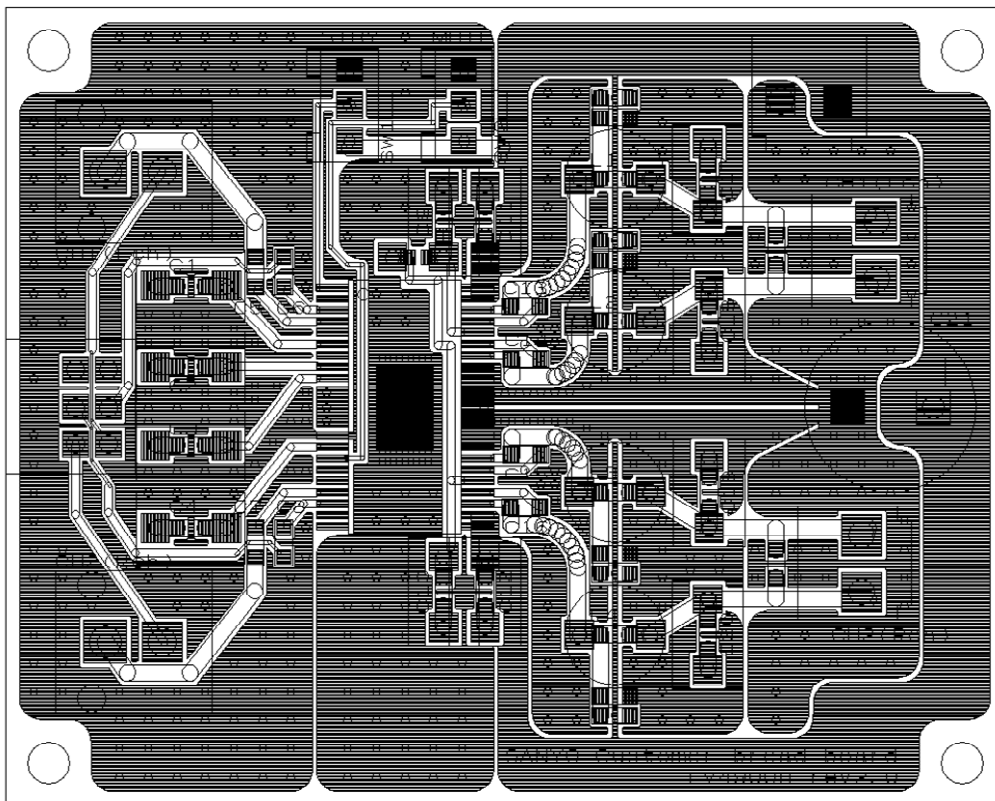


Turn-off time : the time between the point the MUTE pin is set low and the point the STBY pin is set low.

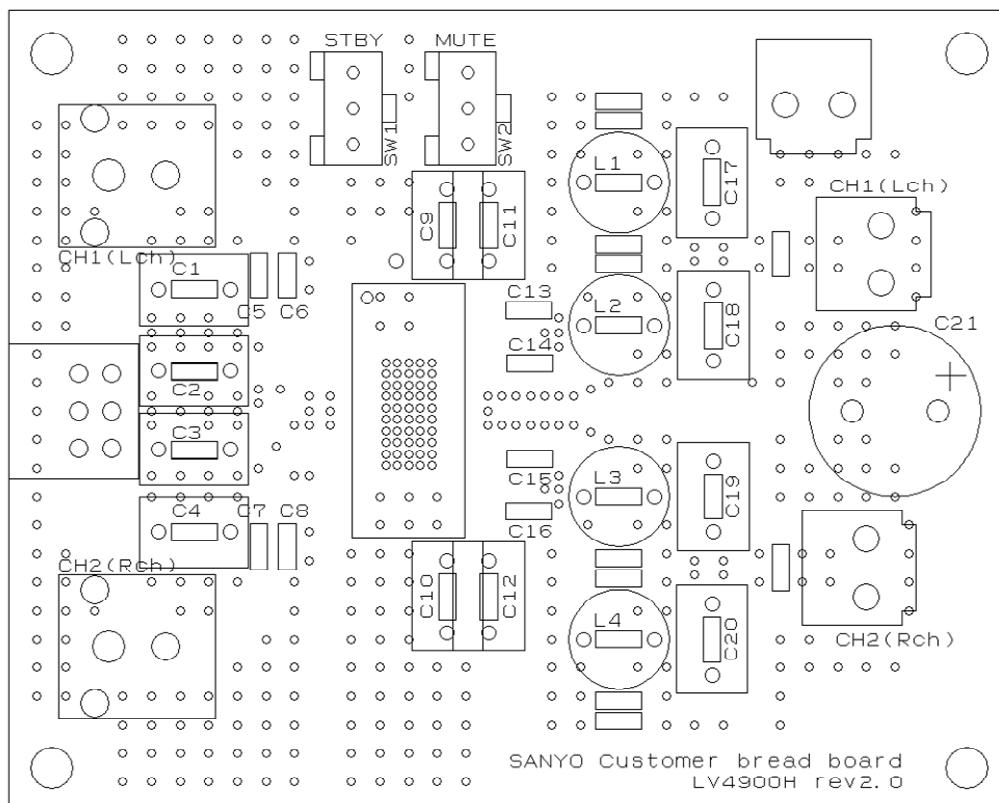
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LV4900H customer bread board rev.2.0

Pattern



Silk

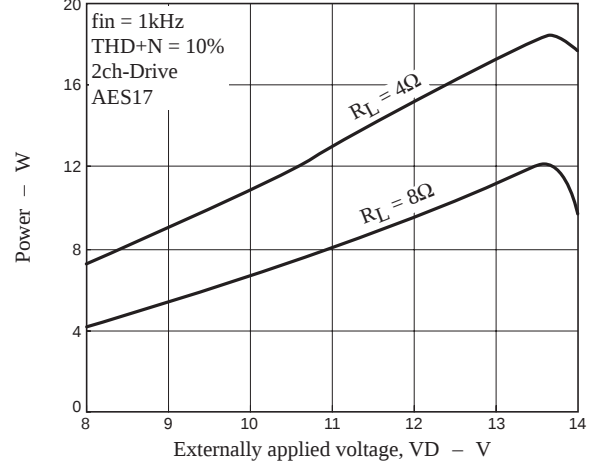
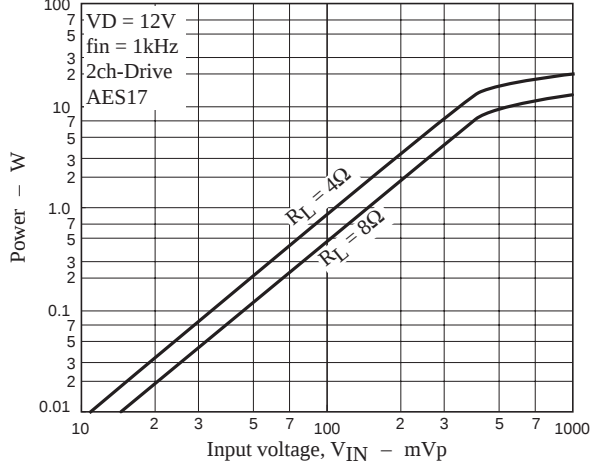
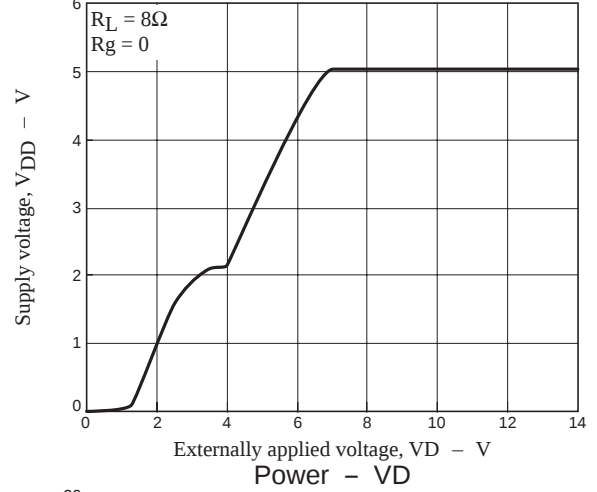
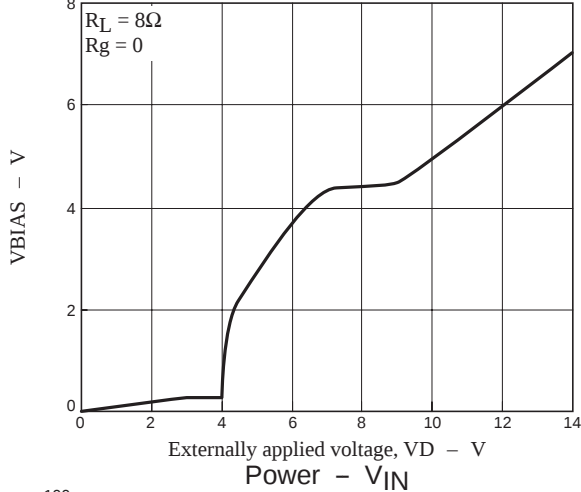
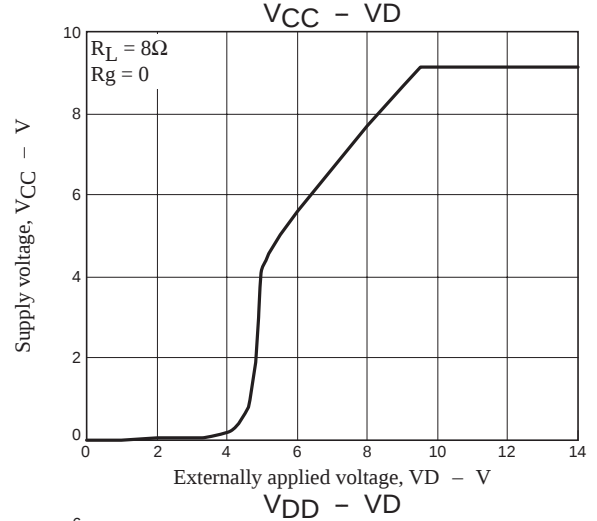
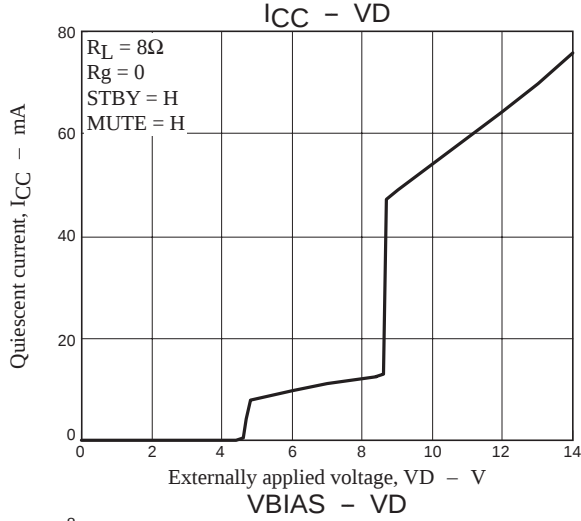
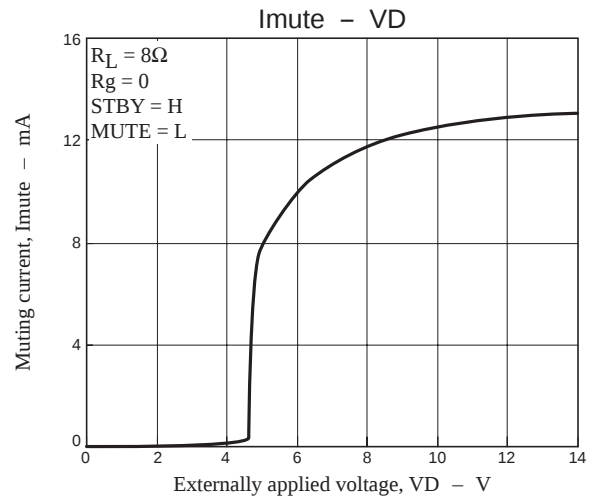
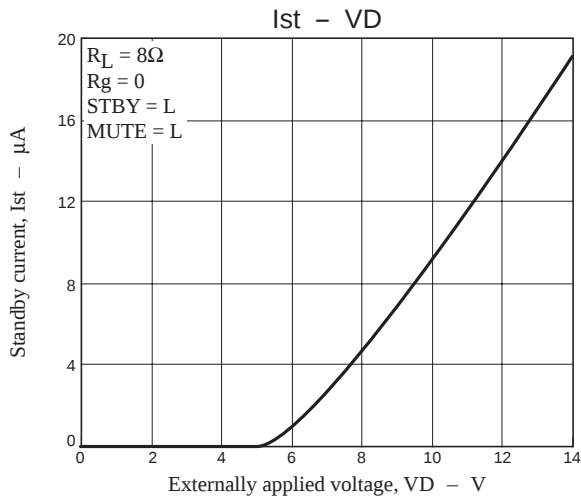


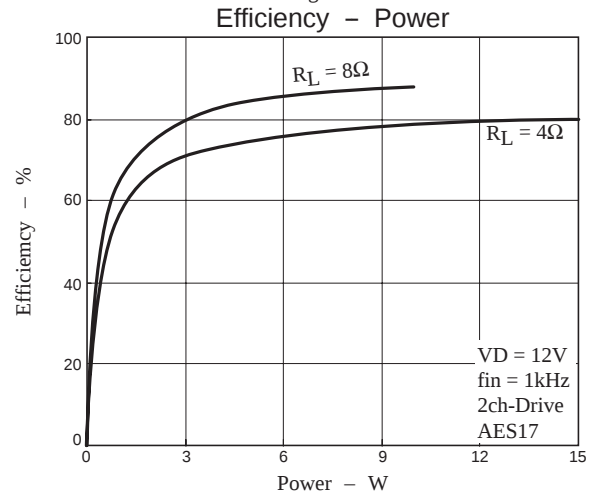
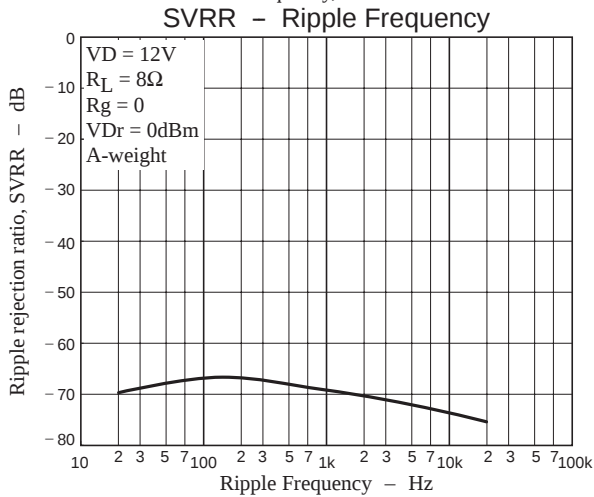
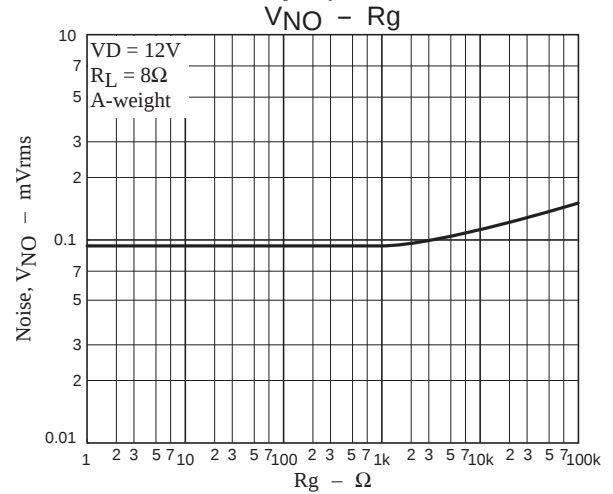
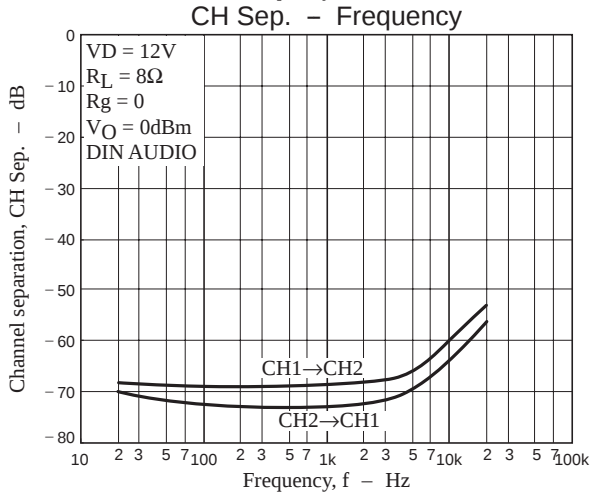
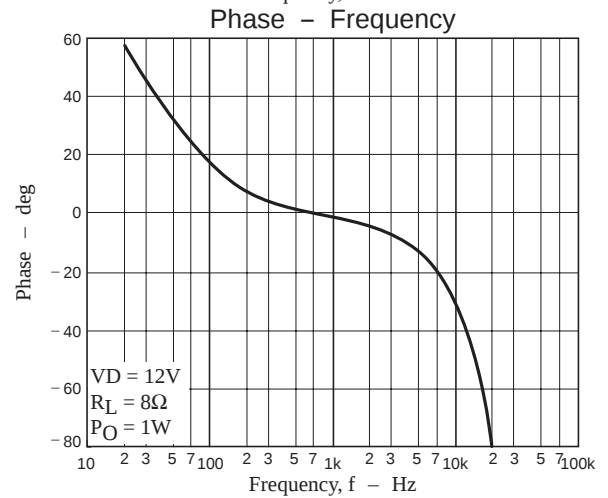
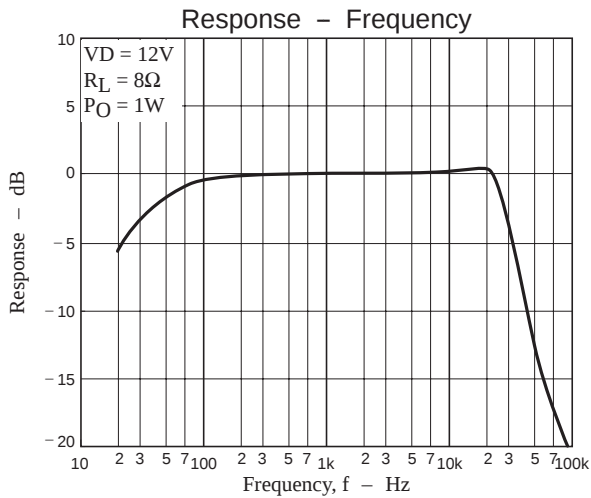
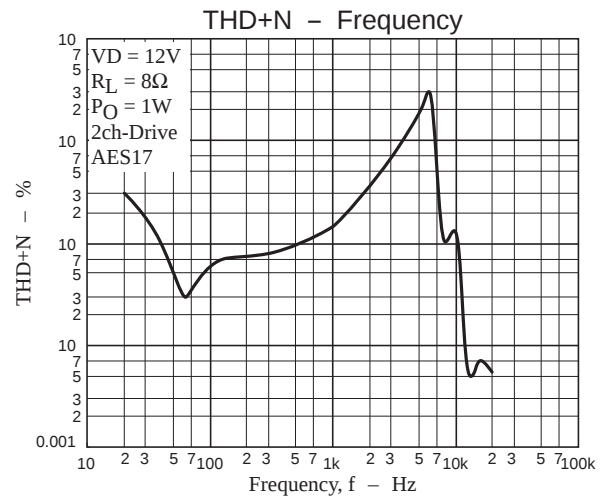
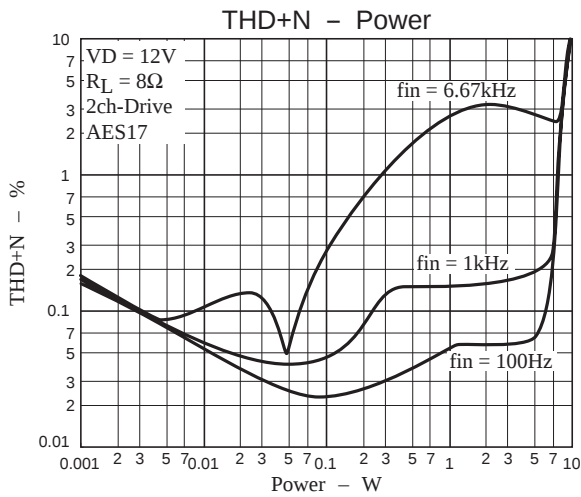
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Components

Symbol	Part No.	Function
-----	SW1	Standby switch. Lower position: standby state
-----	SW2	Mute switch. Lower position: mute state
C _{VCC}	C1	Internal power supply (V _{CC}) output coupling capacitor
C _{BIASCAP}	C2	Internal power supply (V _{BIAS}) input coupling capacitor
C _{VBIAS}	C3	Internal power supply (V _{BIAS}) output coupling capacitor
C _{MUTE}	C4	Soft muting time constant adjustment capacitor
C _{IN}	C5, C6, C7, C8	Input capacitors
* C _{VDD}	C9, C10	Internal power supply (V _{DD}) output coupling capacitors
* C _{VD}	C11, C12	VD high-frequency attenuation capacitors
* C _{BOOT}	C13, C14, C15, C16	Bootstrap capacitor
L _O	L1, L2, L3, L4	Output low-pass filter coils: $f_c = 1 / (2\pi\sqrt{L_O C_O})$
C _O	C17, C18, C19, C20	Output low-pass filter capacitors
C _{VD}	C21	VD power supply capacitors

* C_{VDD}, C_{VD} and C_{BOOT}. Each capacitor is arranged in the neighborhood of IC as much as possible.





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